Qualcomm

RF360
Europe GmbH

Data sheet

SAW RF uplink filter

Base stations
LTE band 3

Series/type:	B5085
Ordering code:	B39172B5085U410
Date:	June 11, 2019
Version:	2.5

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RF360 Europe GmbH

A Qualcomm – TDK Joint Venture

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Table of contents

1 Application

- RF filter for band 3 uplink
- Unbalanced to unbalanced operation
- Low amplitude ripple
- Usable pass band 75 MHz
- No matching required for operation at 50 Ω

2 Features

- Package code DCC6C
- Package size $3.0_{\pm 0.1}$ mm × $3.0_{\pm 0.1}$ mm
- Package height $1.1_{\pm 0.125}$ mm
- Approximate weight 0.04 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Lead free soldering compatible with J-STD20C
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 1 (MSL1)

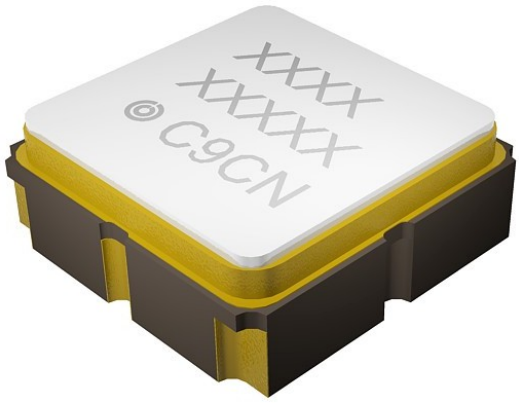

Figure 1: Picture of component with example of product marking.

3 Package

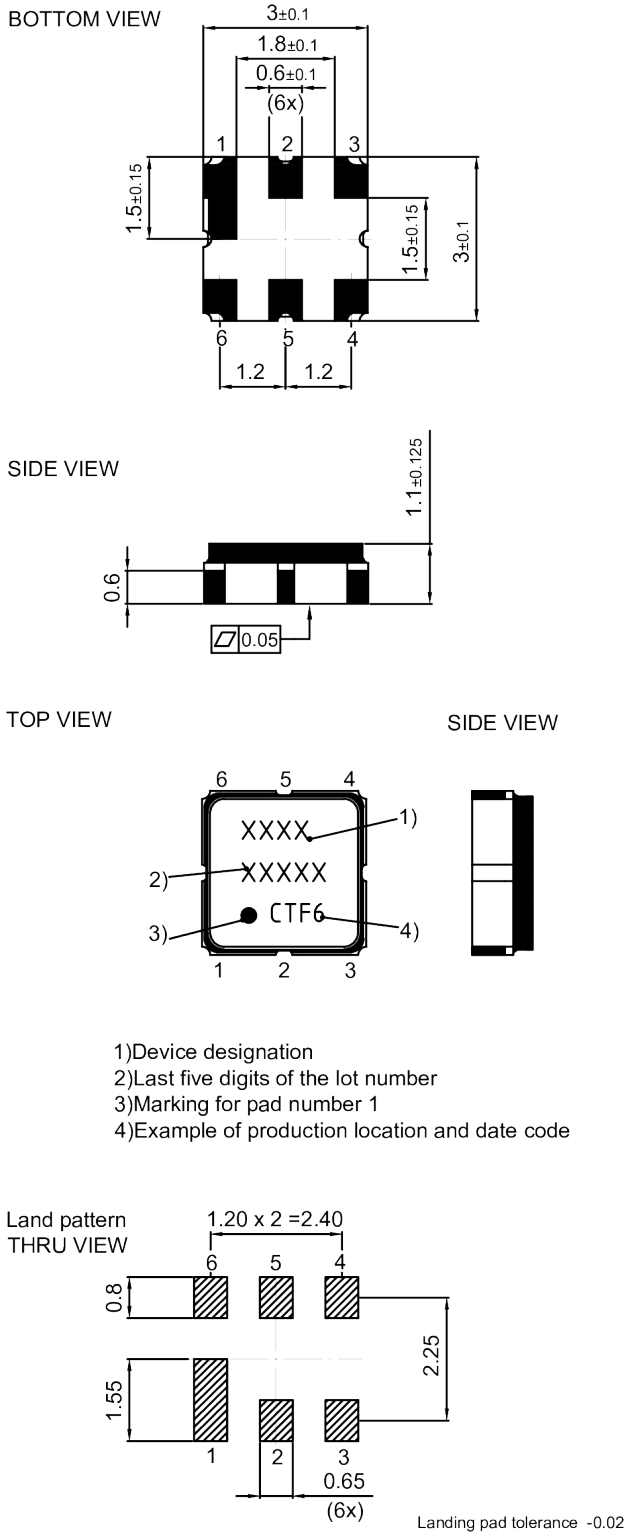

Figure 2: Drawing of package. See Sec. Package information (p. 17).

4 Pin configuration

- 2 Input
- 5 Output
- 1, 3, 4, 6 Ground

5 Matching circuit

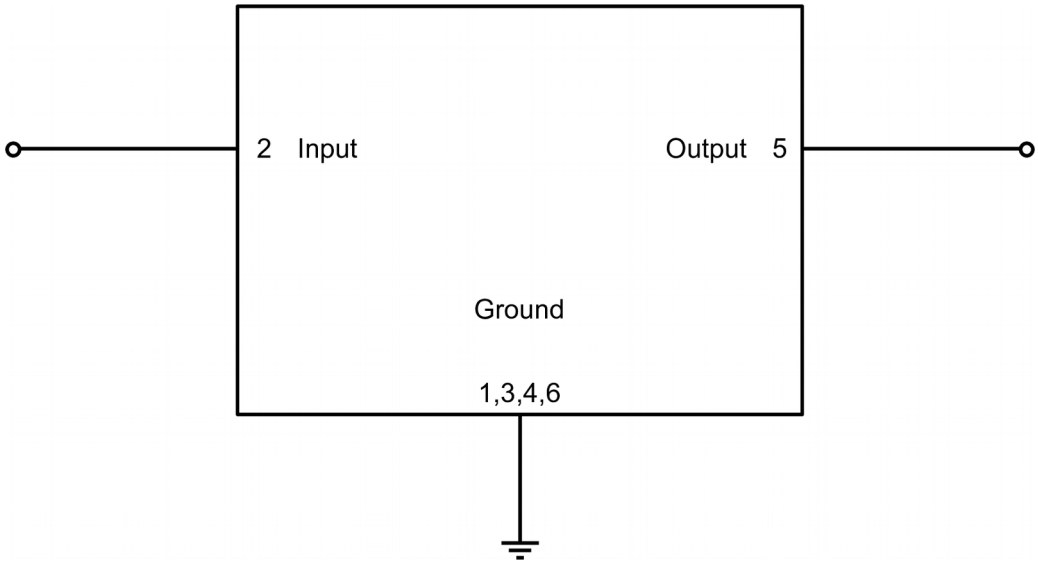

Figure 3: Schematic of matching circuit. No external matching components required.

6 Characteristics

Temperature range for specification T_{SPEC} = −35 °C ... +105 °C
Input terminating impedance Z_{IN} = 50 Ω
Output terminating impedance Z_{OUT} = 50 Ω

Characteristics				min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Center frequency			f_C	—	1747.5	—	MHz
Minimum insertion attenuation			α_{min}				
	1710... 1785	MHz		—	2.5	3.0	dB
Maximum insertion attenuation			α_{max}				
	1710... 1785	MHz		—	3.0	4.0[1)]	dB
	1710... 1785	MHz		—	3.0	4.2	dB
Amplitude ripple (p-p)			$\Delta\alpha$				
	1710... 1785	MHz		—	0.5	0.8[2)]	dB
	1710... 1785	MHz		—	0.5	1.0[1)]	dB
	1710... 1785	MHz		—	0.5	1.2	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	1710... 1785	MHz		—	2.0	2.2	
@ output port	1710... 1785	MHz		—	1.9	2.2	
Minimum attenuation			α_{min}				
	1308... 1383	MHz		35	44	—	dB
	2000... 3000	MHz		20	28	—	dB

1) Valid for temperature T = −35 °C...+100 °C.
2) Valid for temperature T = −30 °C...+100 °C.

7 Maximum ratings

Operable temperature	T_{OP} = −45 °C ... +125 °C	
Storage temperature	T_{STG} [1)] = −45 °C ... +125 °C	
DC voltage	$\lvert V_{DC} \rvert$ = 5.0 V	
ESD voltage	V_{ESD} [2)] = 50 V	Machine model.

1) Not valid for packaging material. Please refer to definition of Shelf life (p. 16).
2) According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

8 Transmission coefficient

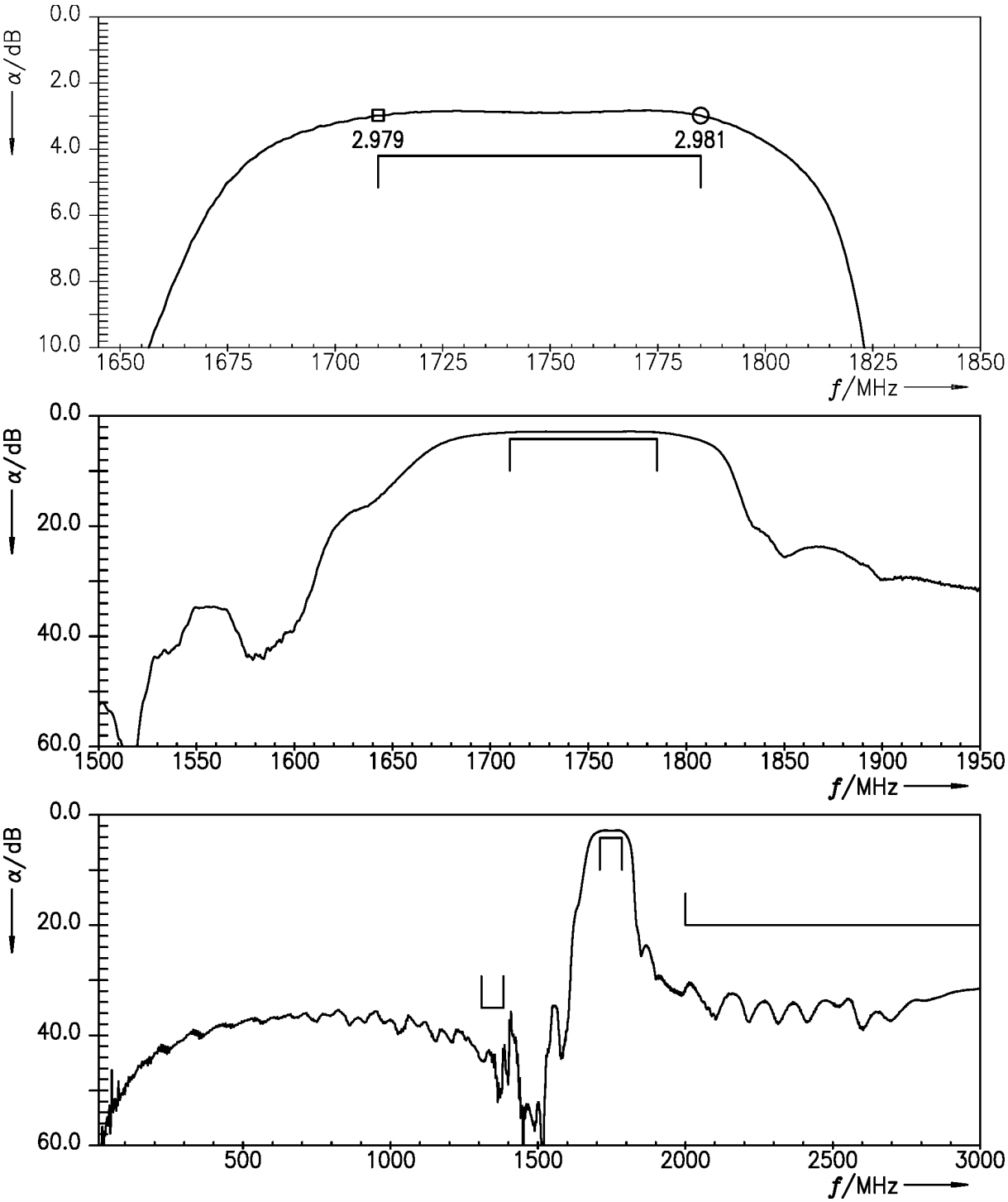

Figure 4: Attenuation.

9 Reflection coefficients

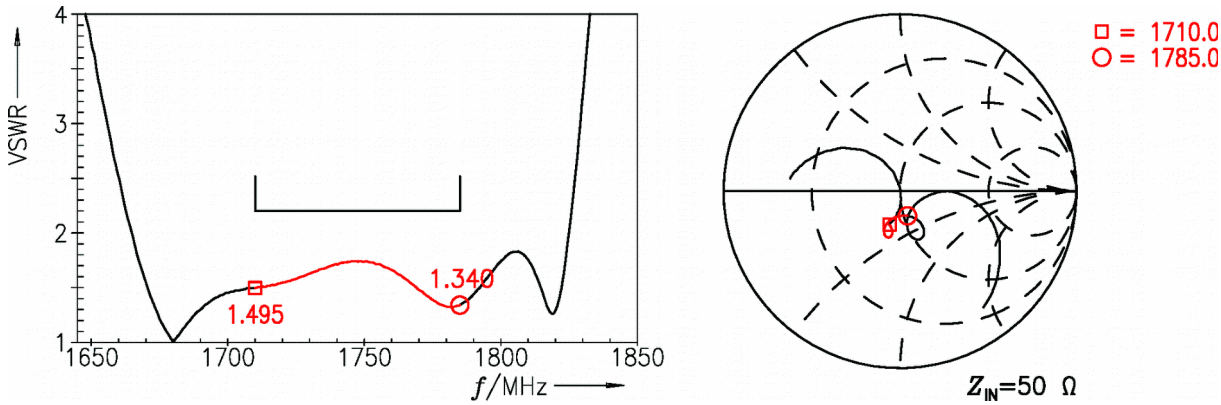

Figure 5: Reflection coefficient at input port.

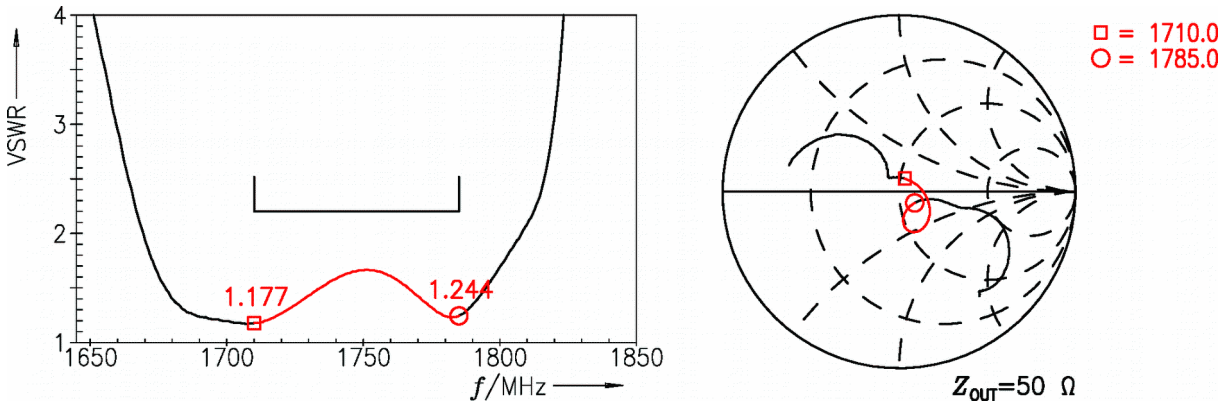

Figure 6: Reflection coefficient at output port.

10 Packing material

10.1 Tape

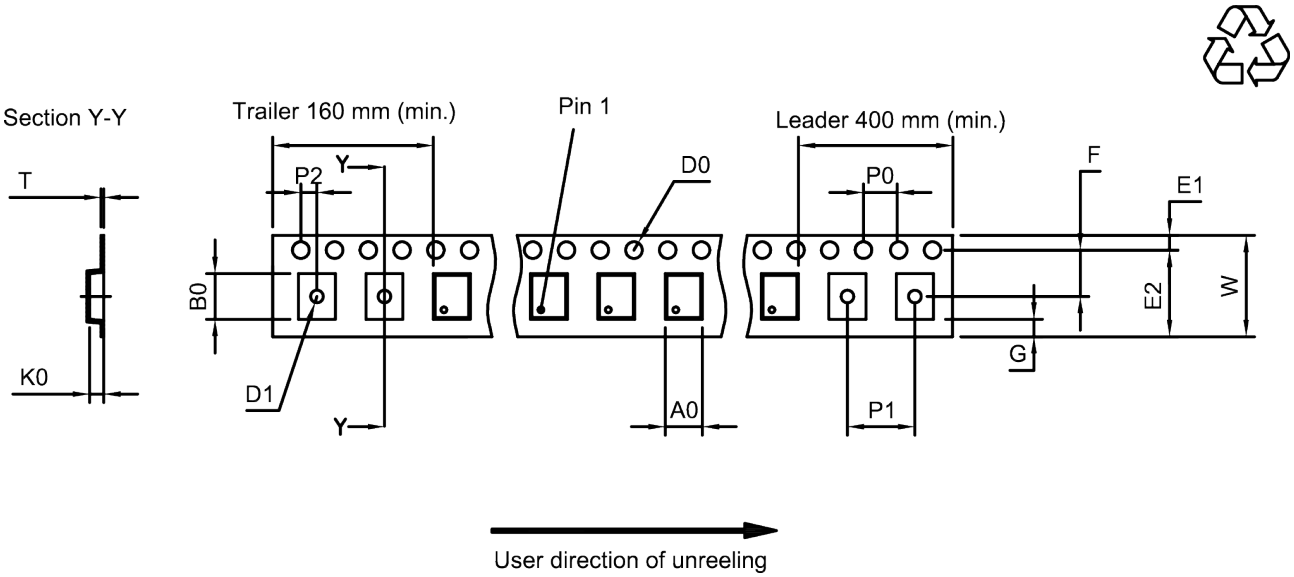

Figure 7: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

A_0	3.25±0.1 mm
B_0	3.3±0.1 mm
D_0	1.5+0.1/−0 mm
D_1	1.5 mm (min.)
E_1	1.75±0.1 mm

E_2	10.25 mm (min.)
F	5.5±0.05 mm
G	0.75 mm (min.)
K_0	1.5±0.1 mm
P_0	4.0±0.1 mm

P_1	4.0±0.1 mm
P_2	2.0±0.1 mm
T	0.3±0.05 mm
W	12.0+0.3/−0.1 mm

Table 1: Tape dimensions.

10.2 Reel with diameter of 180 mm

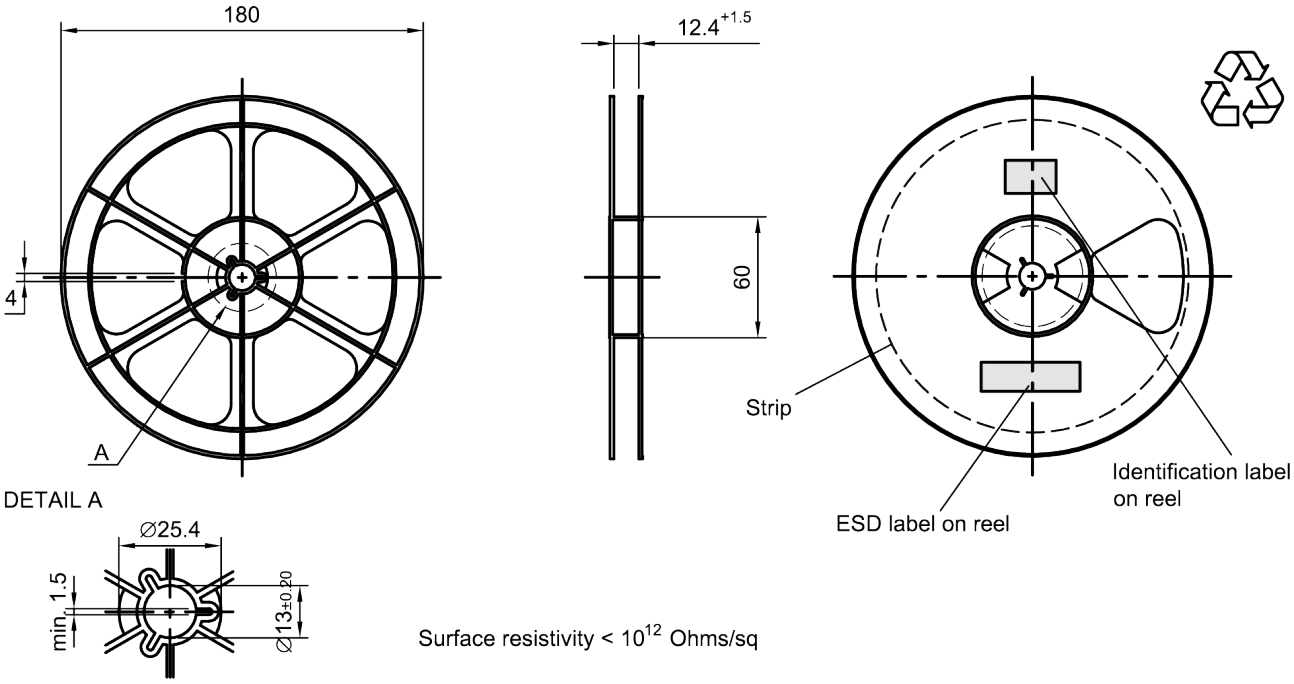

Figure 8: Drawing of reel (first-angle projection) with diameter of 180 mm.

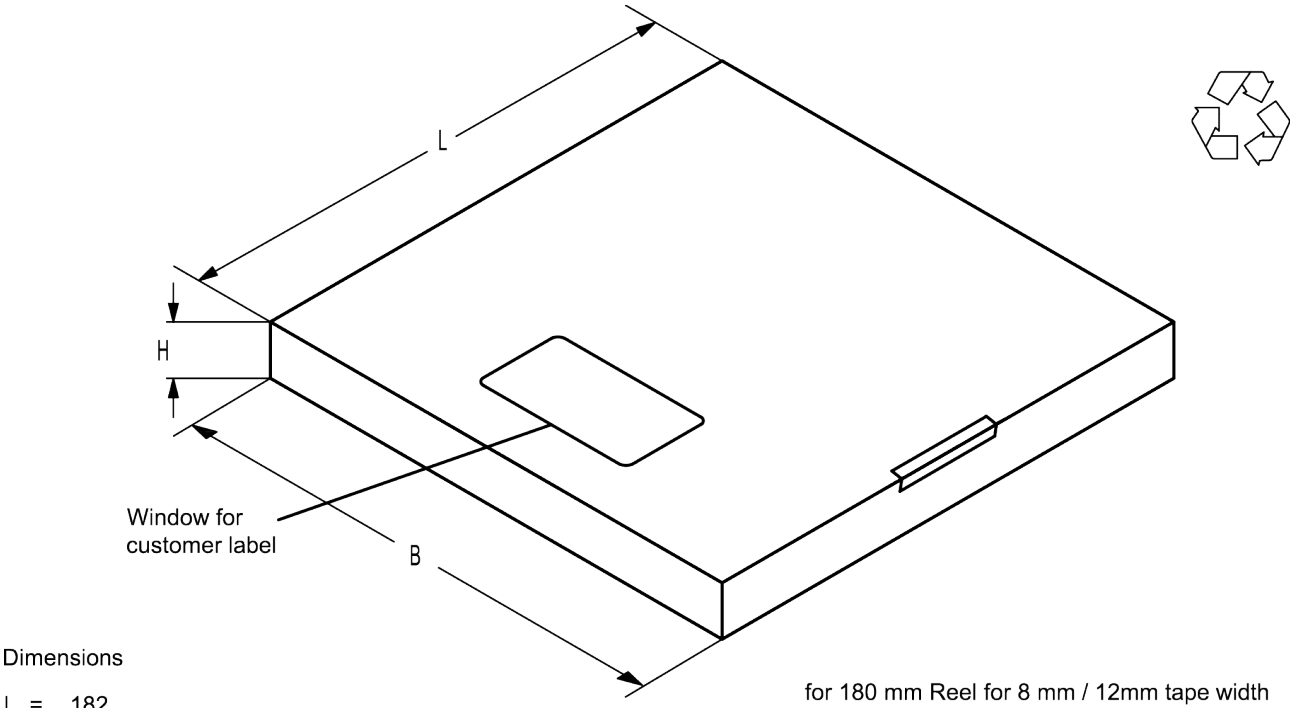

Figure 9: Drawing of folding box for reel with diameter of 180 mm.

10.3 Reel with diameter of 330 mm

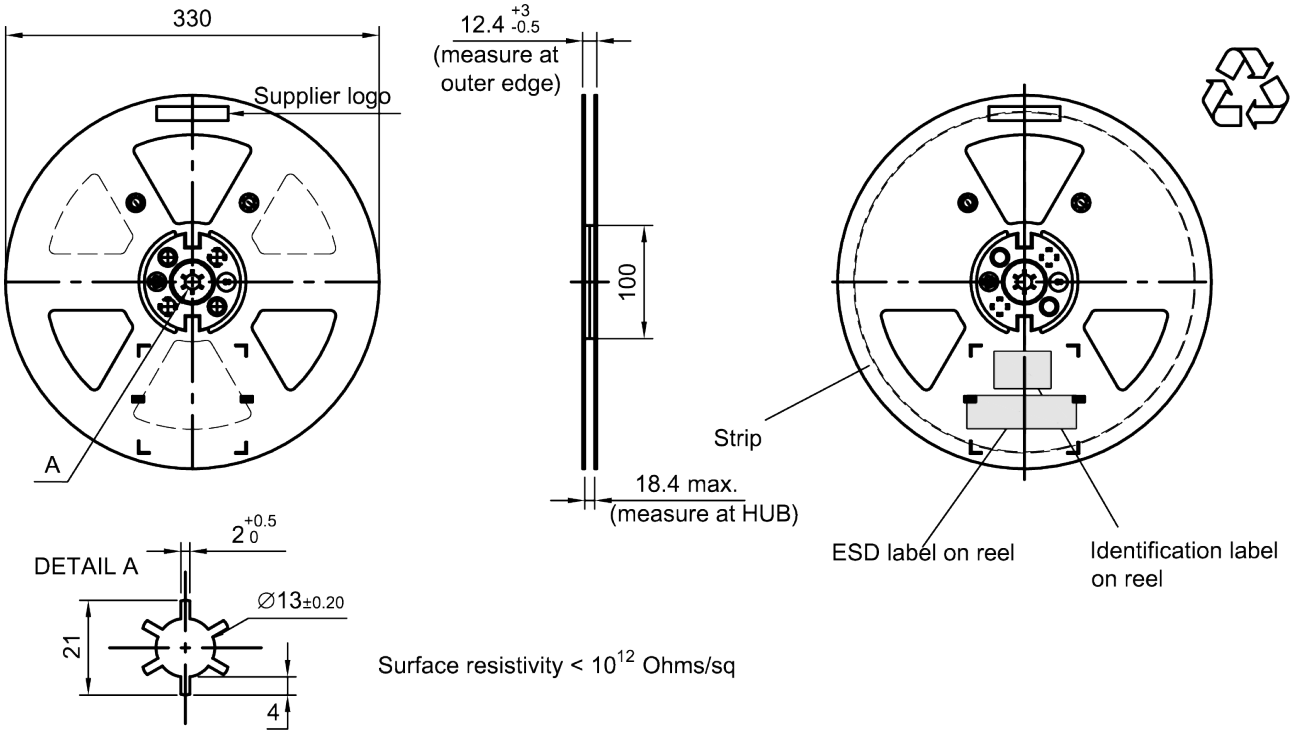

Figure 10: Drawing of reel (first-angle projection) with diameter of 330 mm.

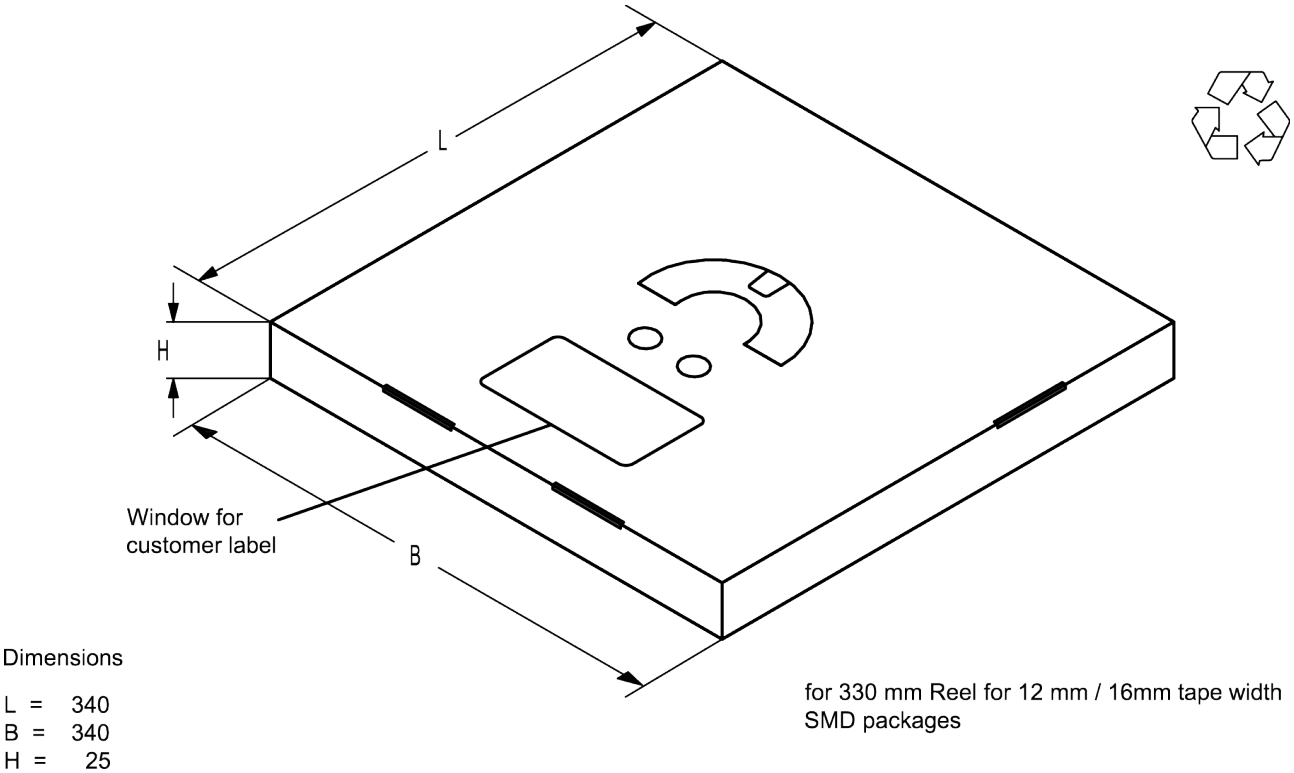

Figure 11: Drawing of folding box for reel with diameter of 330 mm.

11 Marking

Products are marked with device designation, lot number, as well as production location and date code.

- Device designation: The 4-character device designation of the ordering code is used for the marking.

  Example for 4-character device designation: B3xxxxB**1234**xxxx

- Lot number: The last 5 digits of the lot number are used for the marking.

  Example: **12345**

- Production location and date code: The production location is Wuxi (encoded in the first character 'C'). The production date code is encoded in the last three characters according to Table 2.

1st digit (day)					
Day	Code	Day	Code	Day	Code
1	1	11	A	21	M
2	2	12	B	22	N
3	3	13	C	23	P
4	4	14	D	24	R
5	5	15	E	25	S
6	6	16	F	26	T
7	7	17	H	27	U
8	8	18	J	28	V
9	9	19	K	29	W
10	0	20	L	30	X
				31	Z

2nd digit (year)			
Year	Code	Year	Code
2010	A	2022	P
2011	B	2023	R
2012	C	2024	S
2013	D	2025	T
2014	E	2026	U
2015	F	2027	V
2016	H	2028	W
2017	J	2029	X
2018	K	2030	Z
2019	L	2031	A
2020	M	2032	B
2021	N	and so on	

3rd digit (month)			
Month	Code	Month	Code
Jan	1	Jul	7
Feb	2	Aug	8
Mar	3	Sep	9
Apr	4	Oct	0
May	5	Nov	N
Jun	6	Dec	D

Table 2: Production date code.

Example of how to decode production location and date code:

Code: **C T F 6**

Location: C → Wuxi
Day: T → 26th
Year: F → 2015
Month: 6 → June

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
T ≥ 255 °C	–
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

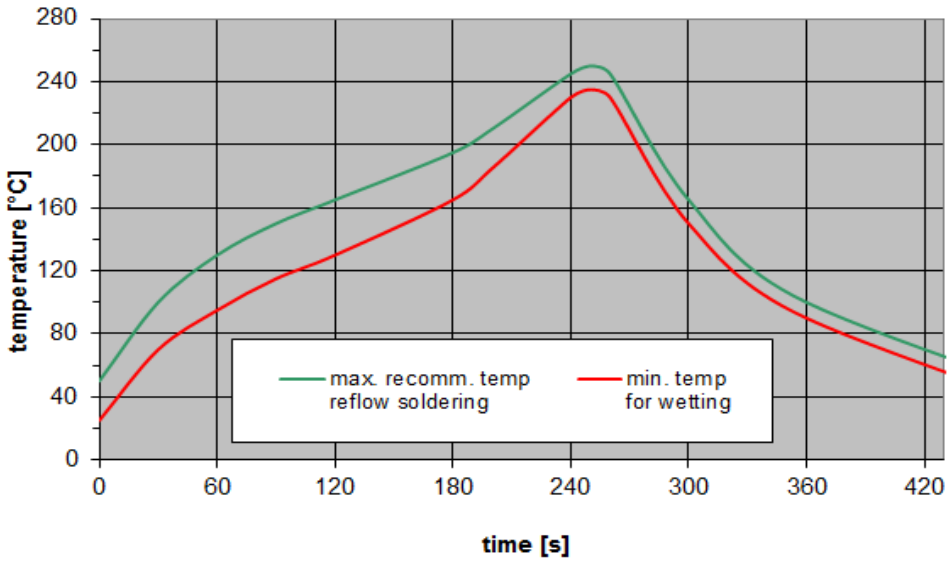

Figure 12: Recommended reflow profile for convection and infrared soldering – lead-free solder.

13 Annotations

13.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

13.3 Shelf life

The shelf life of components is determined by solderability of the package terminals. It is specified as 2 years from manufacturing date assuming the following conditions:

- storage in original packaging and non-aggressive atmosphere,
- storage temperature ranging from −25 °C to +40 °C, and
- storage humidity with ≤ 75 % r.h. mean annual humidity, ≤ 95 % r.h. for max. 30 days / year, and no dew condensation.

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.

15 Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.** As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified.** In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.rf360jv.com/material). Should you have any more detailed questions, please contact our sales offices.
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   The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

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